EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	293	"361"/$.ccls. and mold with (protrus$4 project$4 opening cavit$3) and (chip die ic) and (substrate board carrier) with (via hole opening)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/23 16:22
L2	2113	"257"/$.ccls. and mold with (protrus$4 project$4 opening cavit$3) and (chip die ic) and (substrate board carrier) with (via hole opening)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/23 17:12
L3	2792	"264"/$.ccls. and mold with (protrus$4 project$4 opening cavit$3) and (chip die ic) and (substrate board carrier)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/23 17:13

8/23/2007 5:13:50 PM

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